03-09-06

1P Sapph No. 10/614,807

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IN THE UNITED STATES PATENT AND TRADEMARK OFFICE

The

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Application Serial No	10/614,807
Filing Date	
Inventor	Wuwen Yi et al.
Assignee	Honeywell International Inc.
	1742
	Wilkins, Harry D.
Attorney's Docket No	H0004116-US
Customer No	021567
Title: Copper Sputtering Targets and Me	ethods of Forming Copper Sputtering Targets

RESPONSE TO DECEMBER 8, 2005 OFFICE ACTION

To:

Mail Stop Amendment Commissioner for Patents

P.O. Box 1450

Alexandria, VA 22313-1450

From:

Jennifer J. Taylor, Ph.D. (Tel. 509-624-4276; Fax 509-838-3424).

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AMENDMENTS

Introductory Comments

In reply to the Office Action of December 8, 2005, applicant amends and remarks as follows.